

30 V, N-channel Trench MOSFET

6 September 2019

1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- · Low threshold voltage
- Extended temperature range T_i = 175 °C
- Trench MOSFET technology
- ElectroStatic Discharge (ESD) protection > 500 V HBM (class H1B)
- AEC-Q101 qualified

3. Applications

- Relay driver
- High-speed line driver
- Low-side load switch
- Switching circuits

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-------------------|----------------------------------|---|-----|-----|-----|-----|------|
| V _{DS} | drain-source voltage | T _j = 25 °C | | - | - | 30 | V |
| V _{GS} | gate-source voltage | | | -8 | - | 8 | V |
| I _D | drain current | V _{GS} = 4.5 V; T _{amb} = 25 °C | [1] | - | - | 6 | А |
| Static chara | octeristics | | | | | | |
| R _{DSon} | drain-source on-state resistance | V _{GS} = 4.5 V; I _D = 6 A; T _j = 25 °C | | - | 19 | 24 | mΩ |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

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5. Pinning information

| Table 2. Pinning information | | | | | | | |
|------------------------------|--------|-------------|-------------------------|---------------------|--|--|--|
| Pin | Symbol | Description | Simplified outline | Graphic symbol | | | |
| 1 | G | gate | 3 | D | | | |
| 2 | S | source | | | | | |
| 3 | D | drain | 1 2 TO-236AB (SOT23) | G S 017aaa255 | | | |

6. Ordering information

| Table 3. Ordering information | | | | | | | |
|-------------------------------|----------|--|---------|--|--|--|--|
| Type number | Package | | | | | | |
| | Name | Description | Version | | | | |
| PMV19XNEA | TO-236AB | plastic surface-mounted package; 3 leads | SOT23 | | | | |

7. Marking

Table 4. Marking codes

| Type number | Marking code[1] |
|-------------|-----------------|
| PMV19XNEA | R3% |

[1] % = placeholder for manufacturing site code

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8. Limiting values

Table 5. Limiting values

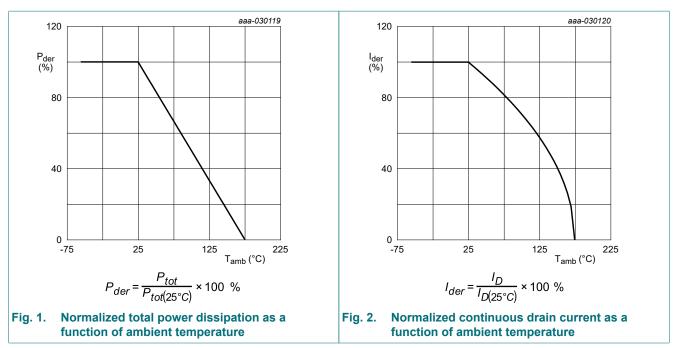
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Мах | Unit |
|----------------------|--|---|-----|-----|-----|------|
| V _{DS} | drain-source voltage | T _j = 25 °C | | - | 30 | V |
| V _{GS} | gate-source voltage | _ | | -8 | 8 | V |
| I _D | drain current | V _{GS} = 4.5 V; T _{amb} = 25 °C | [1] | - | 6 | А |
| | | V _{GS} = 4.5 V; T _{amb} = 100 °C | [1] | - | 3.8 | А |
| I _{DM} | peak drain current | T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$ | | - | 24 | А |
| P _{tot} | total power dissipation | T _{amb} = 25 °C | [2] | - | 610 | mW |
| | | | [1] | - | 1.4 | W |
| | | T _{sp} = 25 °C | | - | 8.3 | W |
| Tj | junction temperature | | | -55 | 175 | °C |
| T _{amb} | ambient temperature | | | -55 | 175 | °C |
| T _{stg} | storage temperature | | | -65 | 175 | °C |
| Source-drai | n diode | | | I | | _ |
| Is | source current | T _{amb} = 25 °C | [1] | - | 1.5 | А |
| ESD maxim | um rating | | | | | |
| V _{ESD} | electrostatic discharge voltage | НВМ | [3] | - | 500 | V |
| Avalanche r | uggedness | | | | | |
| E _{DS(AL)S} | non-repetitive drain- source avalanche energy | $T_{j(init)} = 25 \text{ °C}; I_D = 0.8 \text{ A}; \text{ DUT in}$ avalanche (unclamped) | | - | 12 | mJ |
| | | -1 | | | | |

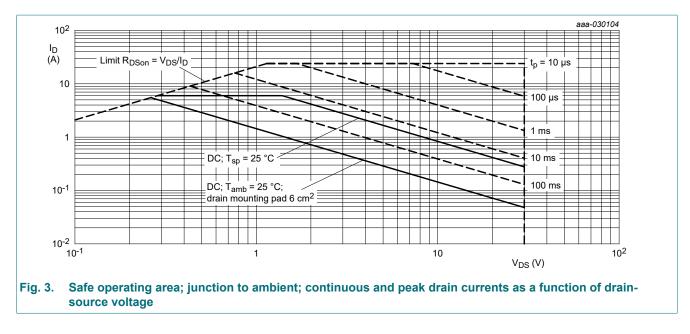
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[3] Measured between all pins.



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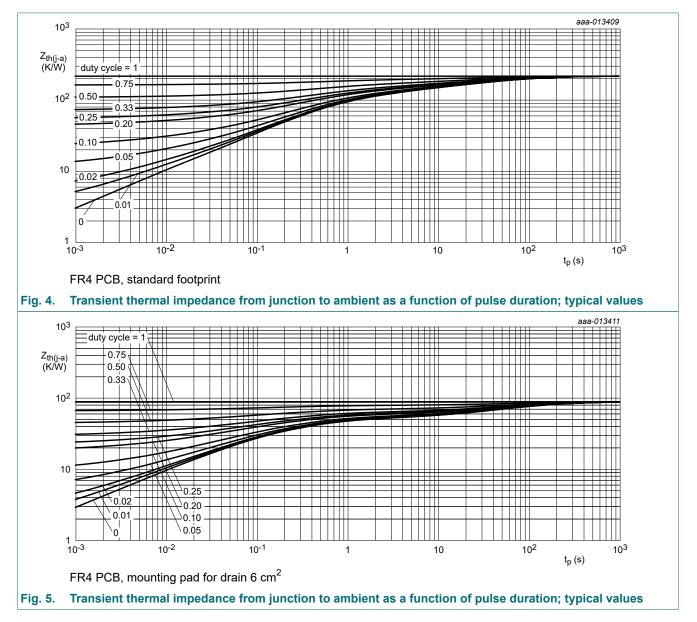


9. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Тур | Мах | Unit |
|-----------------------|--|-------------|-----|-----|-----|-----|------|
| R _{th(j-a)} | thermal resistance from | in free air | [1] | - | 208 | 245 | K/W |
| | junction to ambient | | [2] | - | 88 | 104 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | | - | 13 | 18 | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

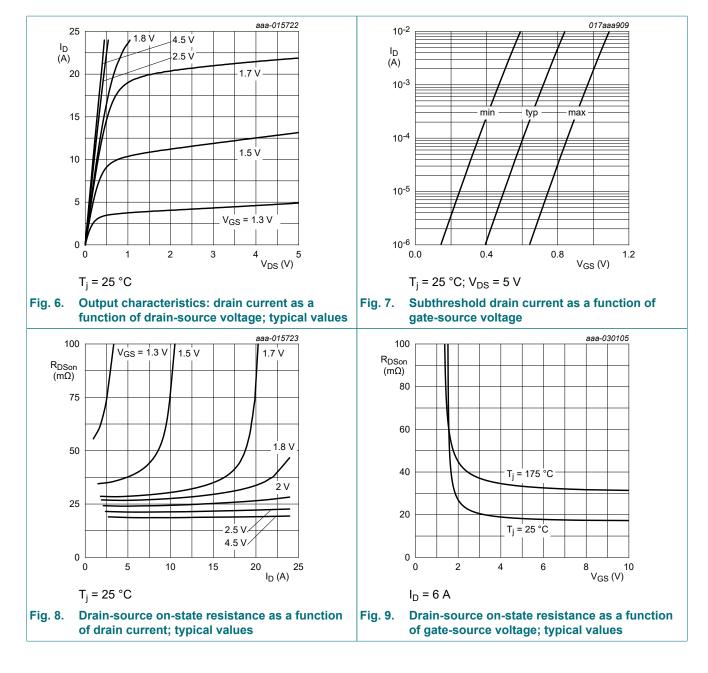
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².



10. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|-----------------------------------|---|-----|------|------|------|
| Static chara | octeristics | | | | | |
| V _{(BR)DSS} | drain-source breakdown voltage | I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C | 30 | - | - | V |
| V _{GSth} | gate-source threshold voltage | I _D = 250 μA; V _{DS} = V _{GS} ; T _j = 25 °C | 0.4 | 0.65 | 0.9 | V |
| I _{DSS} | drain leakage current | V _{DS} = 30 V; V _{GS} = 0 V; T _j = 25 °C | - | - | 1 | μA |
| I _{GSS} | gate leakage current | V _{GS} = 8 V; V _{DS} = 0 V; T _j = 25 °C | - | - | 10 | μA |
| | | V _{GS} = -8 V; V _{DS} = 0 V; T _j = 25 °C | - | - | -10 | μA |
| R _{DSon} | drain-source on-state | V _{GS} = 4.5 V; I _D = 6 A; T _j = 25 °C | - | 19 | 24 | mΩ |
| | resistance | V _{GS} = 4.5 V; I _D = 6 A; T _j = 175 °C | - | 38 | 48 | mΩ |
| | | V _{GS} = 2.5 V; I _D = 4.8 A; T _j = 25 °C | - | 23 | 31 | mΩ |
| | | V _{GS} = 1.8 V; I _D = 1.9 A; T _j = 25 °C | - | 30 | 40 | mΩ |
| 9 _{fs} | forward transconductance | V _{DS} = 10 V; I _D = 5 A; T _j = 25 °C | - | 30 | - | S |
| R _G | gate resistance | f = 1 MHz | - | 2 | - | Ω |
| Dynamic ch | aracteristics | | | | | |
| Q _{G(tot)} | total gate charge | V_{DS} = 15 V; I _D = 5 A; V _{GS} = 4.5 V; | - | 12.4 | 18.6 | nC |
| Q _{GS} | gate-source charge | T _j = 25 °C | - | 1.2 | - | nC |
| Q _{GD} | gate-drain charge | | - | 2.1 | - | nC |
| C _{iss} | input capacitance | V _{DS} = 15 V; f = 1 MHz; V _{GS} = 0 V; | - | 1150 | - | pF |
| C _{oss} | output capacitance | T _j = 25 °C | - | 110 | - | pF |
| C _{rss} | reverse transfer capacitance | | - | 85 | - | pF |
| t _{d(on)} | turn-on delay time | V_{DS} = 15 V; I _D = 5 A; V _{GS} = 4.5 V; | - | 8 | - | ns |
| t _r | rise time | $R_{G(ext)} = 6 \Omega; T_j = 25 °C$ | - | 17 | - | ns |
| t _{d(off)} | turn-off delay time | | - | 33 | - | ns |
| t _f | fall time | | - | 32 | - | ns |
| Source-drai | n diode | · · · | | | | |
| V _{SD} | source-drain voltage | I _S = 1.5 A; V _{GS} = 0 V; T _j = 25 °C | - | 0.7 | 1.2 | V |
| t _{rr} | reverse recovery time | I _S = 1.9 A; dI _S /dt = -100 A/μs; | - | 9 | - | ns |
| Q _r | recovered charge | V _{GS} = 0 V; V _{DS} = 15 V; T _j = 25 °C | - | 2 | - | nC |

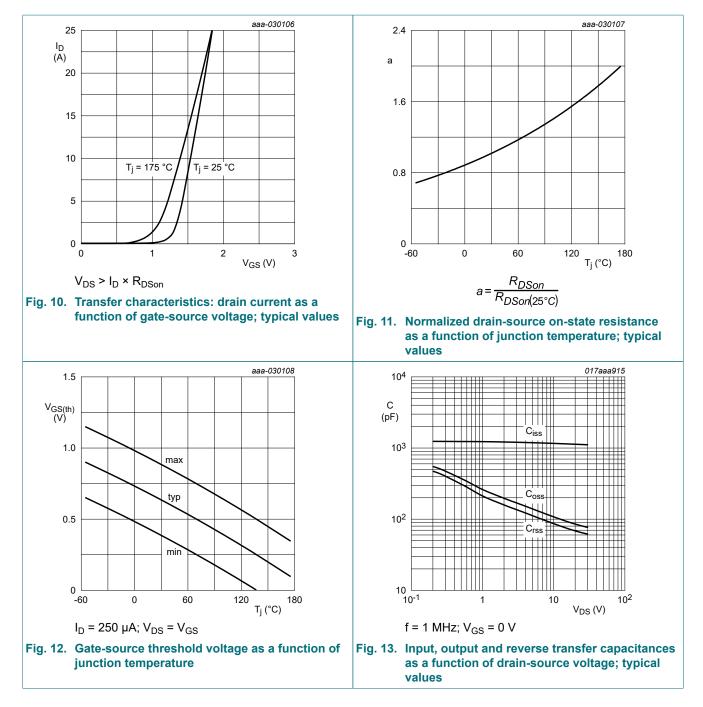
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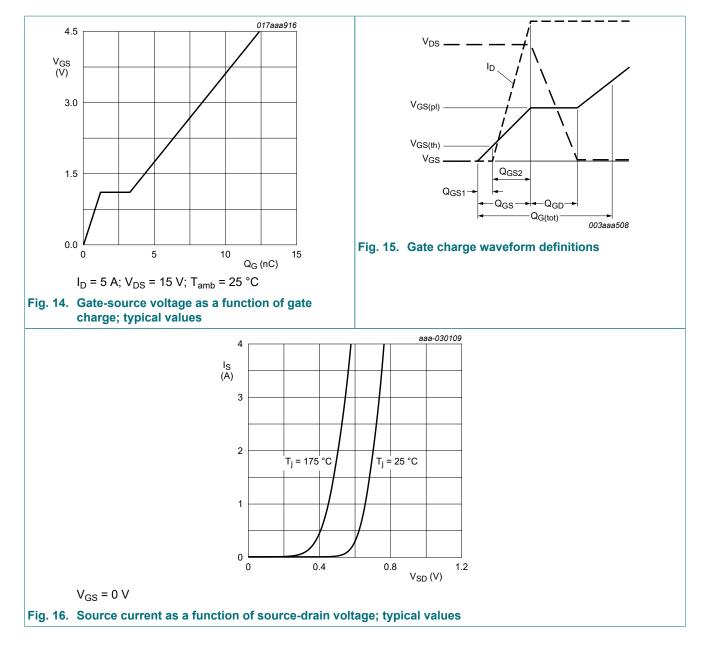
Product data sheet

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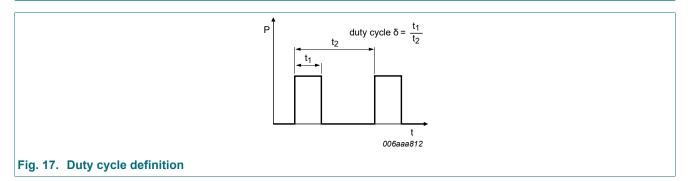
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PMV19XNEA

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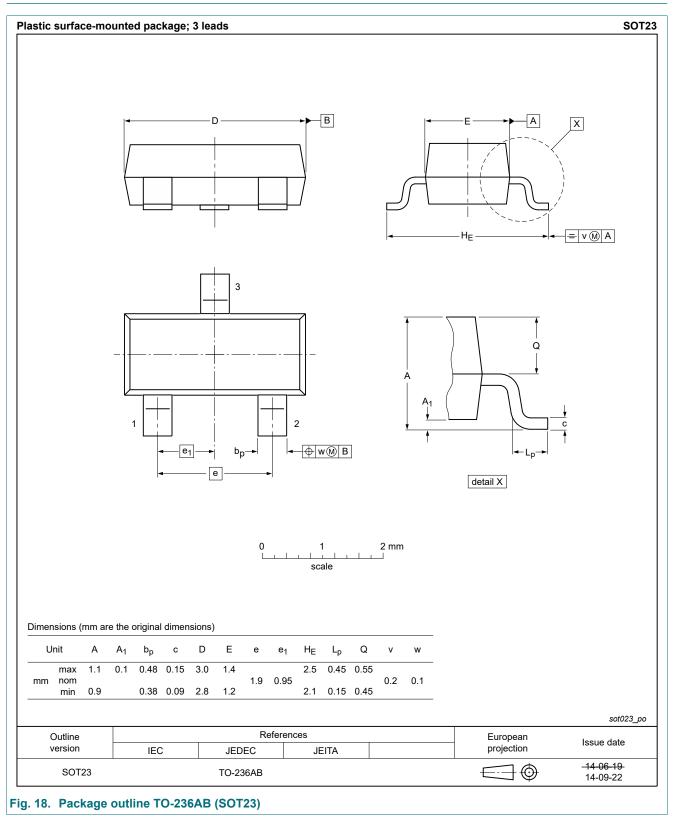
11. Test information



Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

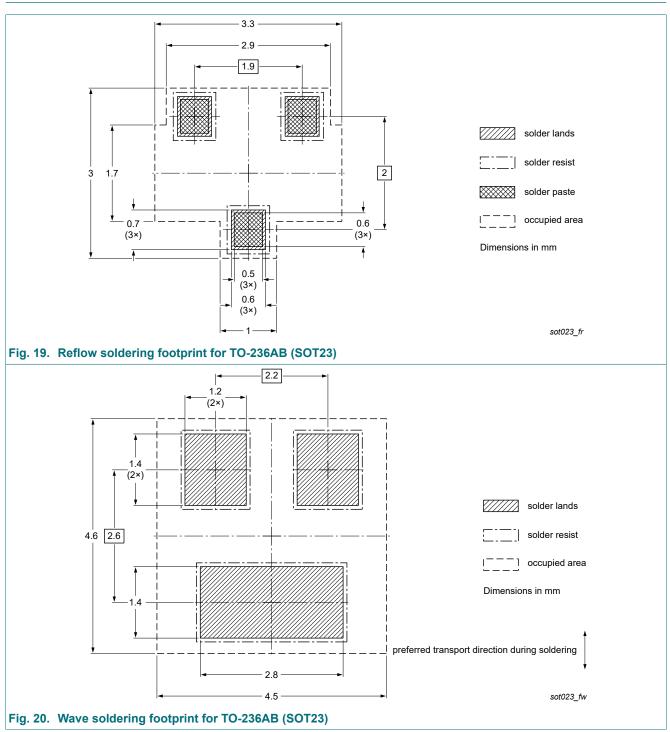
12. Package outline



Product data sheet

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13. Soldering



Product data sheet

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14. Revision history

| Table 8. Revision history | | | | | | |
|---------------------------|--------------|--------------------|---------------|------------|--|--|
| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes | | |
| PMV19XNEA v.1 | 20190906 | Product data sheet | - | - | | |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|-----------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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